



# 20V P-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

| V <sub>(BR)DSS</sub> | R <sub>DS(on)</sub> Max         | <b>I</b> <sub>D</sub> Max<br>@ T <sub>A</sub> = 25°C<br>(Note 4) |
|----------------------|---------------------------------|--|
|                      | 495mΩ @ V <sub>GS</sub> = -4.5V | -0.59A   |
| -20V                 | 690mΩ @ V <sub>GS</sub> = -2.5V | -0.50A   |
|                      | 960mΩ @ V <sub>GS</sub> = -1.8V | -0.42A   |

# **Description and Applications**

This MOSFET has been designed to minimize the on-state resistance  $(R_{DS(on)})$  and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Portable electronics

## **Features and Benefits**

- Footprint of just 3mm<sup>2</sup> less than half the size of SOT23
- 0.8mm profile ideal for low profile applications
- Low Gate Threshold Voltage
- Fast Switching Speed
- ESD Protected Gate 3KV
- Totally Lead-Free & Fully RoHS compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

# **Mechanical Data**

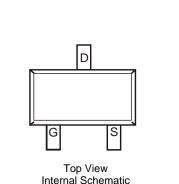
- Case: SOT523
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish ; Solderable per MIL-STD-202, Method 208
- Weight: 0.002 grams (approximate)

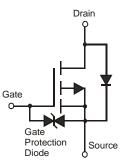




**SOT523** 

Bottom View





Equivalent Circuit

### Ordering Information (Note 3)

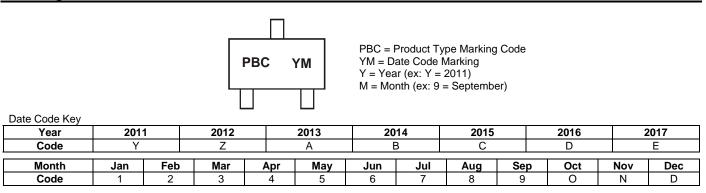
| Part Number | Marking | Reel size (inches) | Tape width (mm) | Quantity per reel |
|-------------|---------|--------------------|-----------------|-------------------|
| DMP21D0UT-7 | PBC     | 7                  | 8               | 3,000             |

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. No purposely added lead. Halogen and Antimony free.

2. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com.

3. For packaging details, go to our website at http://www.diodes.com.

# **Marking Information**





Notes:



# DMP21D0UT

### Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

| Characteristic                              |                 | Symbol   | Value            | Unit<br>V               |     |
|---|-----------------|--|------------------|-------------------------|-----|
| Drain-Source Voltage<br>Gate-Source Voltage |                 |  | V <sub>DSS</sub> |                         | -20 |
|   |                 |  | V <sub>GSS</sub> | ±8                      | V   |
| Continuous Drain Current                    | Steady<br>State | $T_A = 25^{\circ}C$ (Note 4)<br>$T_A = 85^{\circ}C$ (Note 4)<br>$T_A = 25^{\circ}C$ (Note 5) | ID               | -0.59<br>-0.42<br>-0.65 | А   |
| Pulsed Drain Current (Note 6                | )               |  | IDM              | -5.0                    | А   |

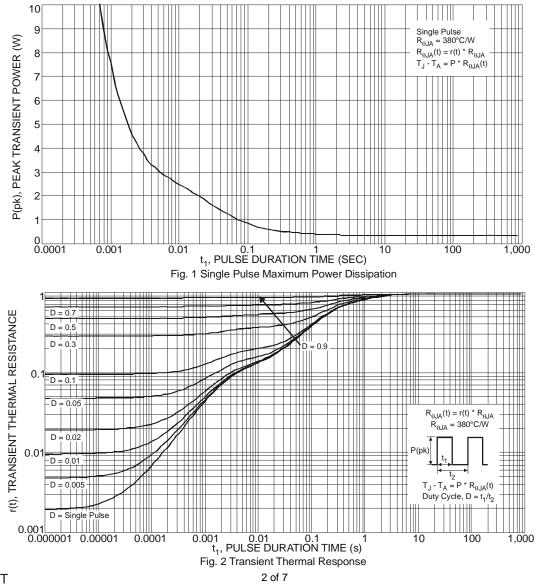
### Thermal Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

| Characteristic                                   | Symbol                            | Value       | Unit |
|--|-----------------------------------|-------------|------|
| Power Dissipation (Note 4)                       | PD                                | 0.24        | W    |
| Power Dissipation (Note 5)                       | PD                                | 0.33        | W    |
| Thermal Resistance, Junction to Ambient (Note 4) | R <sub>0JA</sub>                  | 525         | °C/W |
| Thermal Resistance, Junction to Ambient (Note 5) | R <sub>0JA</sub>                  | 383         | °C/W |
| Operating and Storage Temperature Range          | T <sub>J</sub> , T <sub>STG</sub> | -55 to +150 | °C   |

4. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout

5. Device mounted on 25mm X 25mm FR-4 PCB with high coverage of 2oz copper

6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.



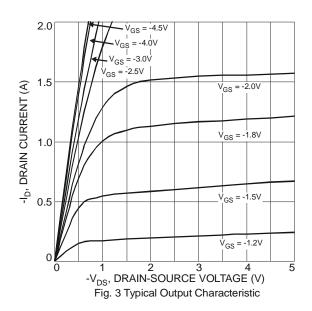
DMP21D0UT Datasheet Number: DS35297 Rev. 2 - 2

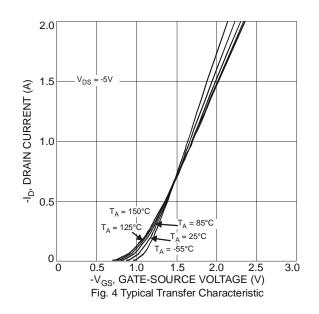




| Characteristic  | Symbol               | Min | Тур  | Max  | Unit | Test Condition  |  |
|---|----------------------|-----|------|------|------|---|--|
| OFF CHARACTERISTICS (Note 7)                          |                      |     |      |      |      |   |  |
| Drain-Source Breakdown Voltage                        | BV <sub>DSS</sub>    | -20 | -    | -    | V    | $V_{GS} = 0V, I_D = -250 \mu A$                                 |  |
| Zero Gate Voltage Drain Current T <sub>J</sub> = 25°C | I <sub>DSS</sub>     | -   | -    | -1   | μA   | $V_{DS} = -20V, V_{GS} = 0V$                                    |  |
| Gate-Source Leakage                                   | IGSS                 | -   | -    | ±10  | μA   | $V_{GS} = \pm 8V, V_{DS} = 0V$                                  |  |
| ON CHARACTERISTICS (Note 7)                           |                      |     | -    | -    |      |   |  |
| Gate Threshold Voltage                                | V <sub>GS(th)</sub>  | -   | -0.7 | -    | V    | $V_{DS} = V_{GS}$ , $I_D = -250 \mu A$                          |  |
|   |                      | -   | -    | 495  | mΩ   | $V_{GS} = -4.5V, I_D = -400mA$                                  |  |
| Static Drain-Source On-Resistance                     | R <sub>DS</sub> (ON) |     |      | 690  |      | $V_{GS} = -2.5V, I_D = -300mA$                                  |  |
|   |                      |     |      | 960  |      | $V_{GS} = -1.8V, I_D = -100mA$                                  |  |
| Forward Transfer Admittance                           | Y <sub>fs</sub>      | 50  | -    | -    | mS   | $V_{DS} = -3V, I_{D} = -300mA$                                  |  |
| Diode Forward Voltage                                 | V <sub>SD</sub>      | -   | -    | -1.2 | V    | $V_{GS} = 0V, I_{S} = -300mA$                                   |  |
| DYNAMIC CHARACTERISTICS                               |                      |     |      |      |      |   |  |
| Input Capacitance                                     | Ciss                 | -   | 76.5 | -    | pF   | − V <sub>DS</sub> = -10V, V <sub>GS</sub> = 0V,<br>− f = 1.0MHz |  |
| Output Capacitance                                    | Coss                 | -   | 13.7 | -    | pF   |   |  |
| Reverse Transfer Capacitance                          | C <sub>rss</sub>     | -   | 10.7 | -    | pF   |   |  |
| Gate Resistance                                       | Rg                   | -   | 195  | -    | Ω    | $V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$                            |  |
| Total Gate Charge                                     | Qg                   |     | 1.5  | -    | nC   | $V_{GS} = -8V, V_{DS} = -15V, I_D = -14$                        |  |
| Total Gate Charge                                     | Qg                   | -   | 1.0  | -    | nC   |   |  |
| Gate-Source Charge                                    | Q <sub>gs</sub>      | -   | 0.2  | -    | nC   | $-V_{GS} = -4.5V, V_{DS} = -15V,$<br>$-I_{D} = -1A$             |  |
| Gate-Drain Charge                                     | Q <sub>gd</sub>      | -   | 0.3  | -    | nC   |   |  |
| Turn-On Delay Time                                    | t <sub>D(on)</sub>   | -   | 7.1  | -    | ns   |   |  |
| Turn-On Rise Time                                     | tr                   | -   | 8.0  | -    | ns   | V <sub>DS</sub> = -10V, -I <sub>D</sub> = 1A                    |  |
| Turn-Off Delay Time                                   | t <sub>D(off)</sub>  | -   | 31.7 | -    | ns   | $V_{\rm GS} = -4.5 \text{V}, \text{ R}_{\rm G} = 6 \Omega$      |  |
| Turn-Off Fall Time                                    | t <sub>f</sub>       | -   | 18.5 | -    | ns   |   |  |

7. Short duration pulse test used to minimize self-heating effect. Notes:







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 $_{\Lambda} = 150^{\circ}C$ 

<sub>A</sub> = 125°C

T<sub>A</sub> = 85°C

 $T_A = 25^{\circ}C$ 

T<sub>A</sub> = -55°C

0.8

V<sub>GS</sub> = -5.0V  $I_{D} = -500 \text{mA}$ 

25

50

0.8

75

T<sub>A</sub> = 25°C

1.0

1.2

-I<sub>D</sub>, DRAIN CURRENT (A)

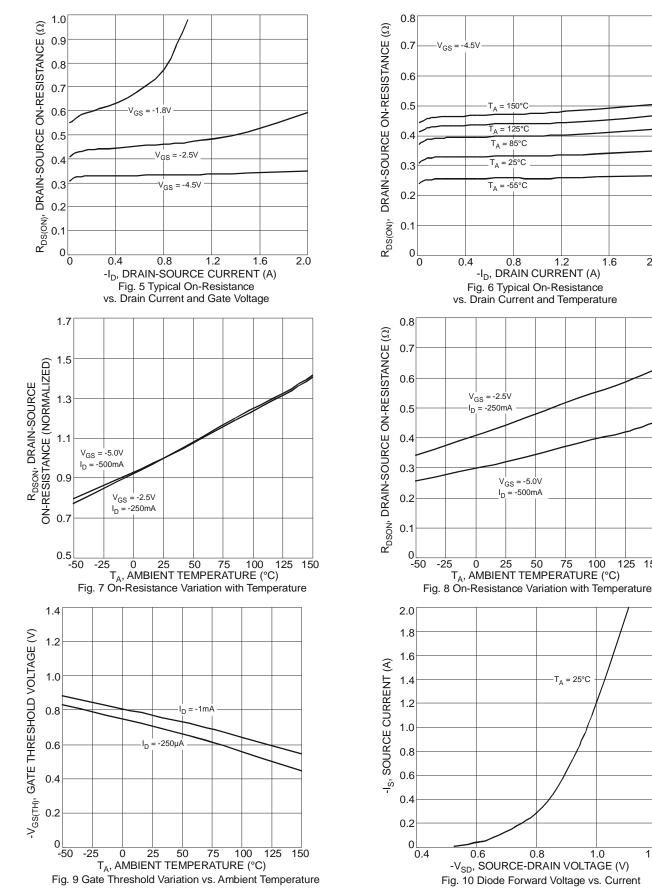
1.6

100 125 150

2.0



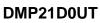
DMP21D0UT

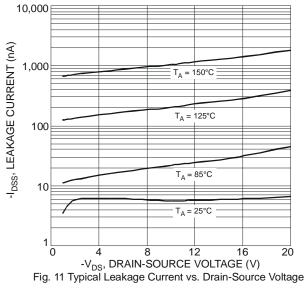


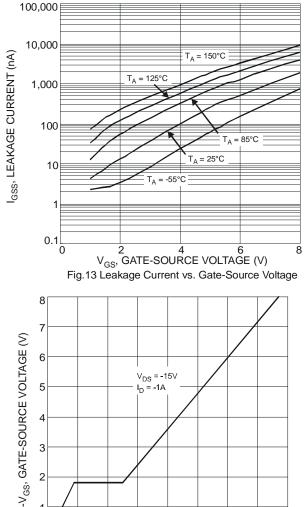
1.2











0.6

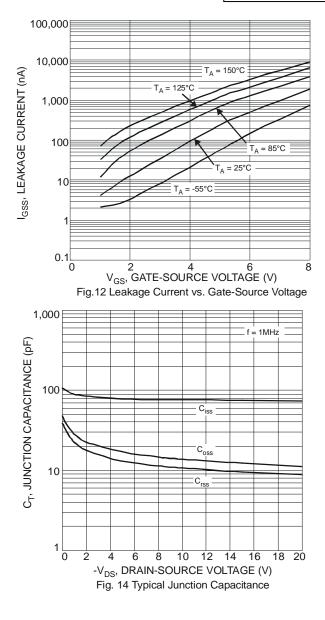
0.4

0.8

Q<sub>g</sub>, TOTAL GATE CHARGE (nC) Fig. 15 Gate-Charge Characteristics

1.0

1.2



0.2

1

0 0

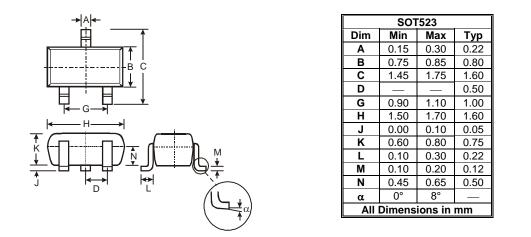
1.6

1.4

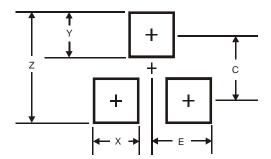




# **Package Outline Dimensions**



# **Suggested Pad Layout**



| Dimensions | Value (in mm) |
|------------|---------------|
| Z          | 1.8           |
| Х          | 0.4           |
| Y          | 0.51          |
| С          | 1.3           |
| E          | 0.7           |





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